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Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China







DATA SHEET

General Description

The IDT8T49N222I is a highly flexible FemtoClock® NG general purpose, low phase noise Frequency Translator / Synthesizer with alarm and monitoring functions suitable for networking and communications applications. It is able to generate any output frequency in the 7.29MHz to 833.33MHz range and most output frequencies in the 925MHz to 1200MHz range (see Table 3A for details). A wide range of input reference clocks and a range of low-cost fundamental mode crystal frequencies may be used as the source for the output frequency.

The IDT8T49N222I has three operating modes to support a very broad spectrum of applications:

- 1) Frequency Synthesizer
 - Synthesizes output frequencies from a 16MHz 40MHz fundamental mode crystal.
 - Fractional feedback division is used, so there are no requirements for any specific crystal frequency to produce the desired output frequency with a high degree of accuracy.
- 2) High-Bandwidth Frequency Translator
 - Applications: PCI Express, Computing, General Purpose
 - Translates any input clock in the 16MHz 710MHz frequency range into any supported output frequency.
 - This mode has a high PLL loop bandwidth in order to track input reference changes, such as Spread-Spectrum Clock modulation, so it will not attenuate much jitter on the input reference.
- 3) Low-Bandwidth Frequency Translator
 - Applications: Networking & Communications.
 - Translates any input clock in the 8kHz –710MHz frequency range into any supported output frequency.
 - This mode supports PLL loop bandwidths in the 10Hz 580Hz range and makes use of an external crystal to provide significant jitter attenuation.

This device provides a factory-programmed default power-up configuration burned into One-Time Programmable (OTP) memory. The configuration is specified by the customer and is programmed by IDT during the final test phase from an on-hand stock of blank devices.

To implement other configurations, these power-up default settings can be overwritten after power-up using the $l^{\rm 2}C$ interface and the device can be completely reconfigured. However, these settings would have to be written every time the device powers-up.

Features

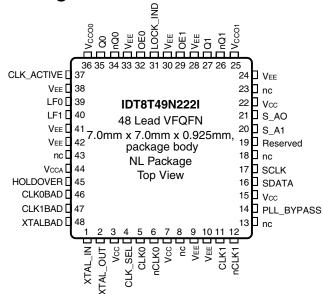
- Fourth generation FemtoClock® NG technology
- Universal Frequency Translator
 - Zero ppm frequency translation
- · Two outputs, individually programmable as LVPECL or LVDS
 - Outputs may be individually set to use 2.5V or 3.3V output levels
 - Individually programmable output frequencies: 7.29MHz up to 1200MHz
- Two differential inputs support the following input types: LVPECL, LVDS, LVHSTL, HCSL
 - · Input frequency range: 8kHz to 710MHz
- · Hitless switching between inputs
- Crystal input frequency range: 16MHz to 40MHz
 - Holdover support in the event both inputs fail
- One factory-set register configuration for power-up default state
 - Configurations customized via One-Time Programmable ROM
 - Settings may be overwritten after power-up via I²C
 - I²C Serial interface for register programming
- RMS phase jitter at 156.25MHz, using a 40MHz crystal (12kHz - 20MHz): 507fs (typical), Low Bandwidth Mode (FracN)
- Supports ITU-T G.8262 Synchronous Ethernet equipment slave clocks (EEC option 1 and 2)
- Output supply voltage modes:

V_{CC}/V_{CCA}/V_{CCOx} 3.3V/3.3V/3.3V 3.3V/3.3V/2.5V (LVPECL only)

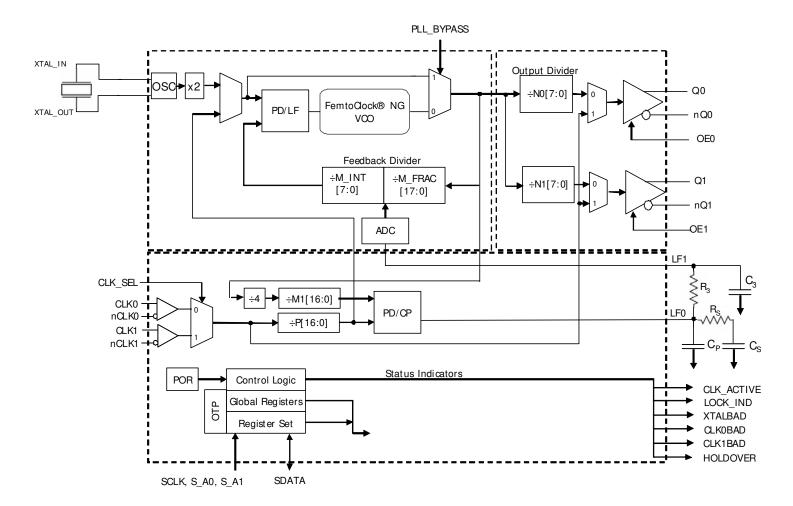
2.5V/2.5V/2.5V 2.5V/2.5V/2.5V

- -40°C to 85°C ambient operating temperature
- · Available in lead-free (RoHS 6) package

Pin Assignment



Block Diagram



Pin Descriptions and Pin Characteristic Tables

Table 1. Pin Descriptions

Number	Name	T	ype	Description
1 2	XTAL_IN XTAL_OUT	Input		Crystal Oscillator interface designed for 12pF parallel resonant crystals. XTAL_IN (pin 1) is the input and XTAL_OUT (pin 2) is the output.
3, 7, 15, 22	V _{CC}	Power		Core supply pins. All must be either 3.3V or 2.5V.
4	CLK_SEL	Input	Pulldown	Input clock select. Selects the active differential clock input. 0 = CLK0, nCLK0 (default) 1 = CLK1, nCLK1
5	CLK0	Input	Pulldown	Non-inverting differential clock input.
6	nCLK0	Input	Pullup/ Pulldown	Inverting differential clock input. $V_{CC}/2$ default when left floating (set by the internal pullup and pulldown resistors).
8, 13, 18, 23, 43	nc	Unused		No connect. These pins are to be left unconnected.
9, 10, 24, 28, 30, 33, 38, 41, 42	V _{EE}	Power		Negative supply pins.
11	CLK1	Input	Pulldown	Non-inverting differential clock input.
12	nCLK1	Input	Pullup/ Pulldown	Inverting differential clock input. $V_{CC}/2$ default when left floating (set by the internal pullup and pulldown resistors).
14	PLL_BYPASS	Input	Pulldown	Bypasses the VCXO PLL. 0 = PLL Mode (default) 1 = PLL Bypassed
16	SDATA	I/O	Pullup	I ² C Data Input/Output. Open drain.
17	SCLK	Input	Pullup	I ² C Clock Input. LVCMOS/LVTTL Interface Levels.
19	Reserved	Unused		Must be left unconnected.
20	S_A1	Input	Pulldown	I ² C Address Bit 1. LVCMOS/LVTTL Interface Levels.
21	S_A0	Input	Pulldown	I ² C Address Bit 0. LVCMOS/LVTTL Interface Levels.
25	V _{CCO1}	Power		Output supply pins for Q1, nQ1 outputs. Either 2.5V or 3.3V.
26, 27	nQ1, Q1	Output		Differential output. Output type is programmable to LVDS or LVPECL interface levels.
29	OE1	Input	Pullup	Active High Output Enable for Q1, nQ1. 0 = Output pins high-impedance 1 = Output switching (default)
31	LOCK_IND	Output		Lock Indicator - indicates that the PLL is in a locked condition. LVCMOS/LVTTL interface levels.
32	OE0	Input	Pullup	Active High Output Enable for Q0, nQ0. 0 = Output pins high-impedance 1 = Output switching (default)
34, 35	nQ0, Q0	Output		Differential output. Output type is programmable to LVDS or LVPECL interface levels.
36	V _{CCO0}	Power		Output supply pins for Q0, nQ0 outputs. Either 2.5V or 3.3V.
37	CLK_ACTIVE	Output		Indicates which of the two differential clock inputs is currently selected. 0 = CLK0, nCLK0 differential input pair 1 = CLK1, nCLK1 differential input pair
39, 40	LF0, LF1	Input		Loop filter connection node pins. LF0 is the output. LF1 is the input.

Table 1. Pin Descriptions

Number	Name	Туре	Description
Continued or	next page.		·
44	V _{CCA}	Power	Analog supply voltage.
45	HOLDOVER	Output	Alarm output reflecting if the device is in a holdover state. LVCMOS/LVTTL interface levels. 0 = Device is locked to a valid input reference 1 = Device is not locked to a valid input reference
46	CLK0BAD	Output	Alarm output reflecting the state of CLK0. LVCMOS/LVTTL interface levels. 0 = Input Clock 0 is switching within specifications 1 = Input Clock 0 is out of specification
47	CLK1BAD	Output	Alarm output reflecting the state of CLK1. LVCMOS/LVTTL interface levels. 0 = Input Clock 1 is switching within specifications 1 = Input Clock 1 is out of specification
48	XTALBAD	Output	Alarm output reflecting the state of XTAL. LVCMOS/LVTTL interface levels. 0 = crystal is switching within specifications 1 = crystal is out of specification

NOTE: Pullup and Pulldown refer to internal input resistors. See Table 2, Pin Characteristics, for typical values.

Table 2. Pin Characteristics

Symbol	Parameter		Test Conditions	Minimum	Typical	Maximum	Units
C _{IN}	Input Capaci	tance			3.5		pF
R _{PULLUP}	Input Pullup	Resistor			51		kΩ
R _{PULLDOWN}	Input Pulldov	vn Resistor			51		kΩ
D	Output	HOLDOVER, CLK_ACTIVE, CLK0BAD, CLK1BAD, XTALBAD, LOCK_IND	V _{CC} = 3.465V		25		Ω
R _{OUT} Impe	Impedance	HOLDOVER, CLK_ACTIVE, CLK0BAD, CLK1BAD, XTALBAD, LOCK_IND	V _{CC} = 2.625V		25		Ω

Functional Description

The IDT8T49N222I is designed to provide two output frequencies almost anywhere within its supported output frequency range (7.29MHz to 1200MHz) from any input source in the supported input frequency range (8kHz to 710MHz). It is capable of synthesizing frequencies from a crystal or crystal oscillator source. The output frequency is generated regardless of the relationship to the input frequency. The output frequency will be exactly the required frequency in most cases. In most others, it will only differ from the desired frequency by a few ppb. IDT configuration software will indicate the frequency error, if any. The IDT8T49N222I can translate the desired output frequency from one of two input clocks. Again, no relationship is required between the input and output frequencies in order to translate to the output clock rate. In this frequency translation mode, a low-bandwidth, jitter attenuation option is available that makes use of an external fixed-frequency crystal or crystal oscillator to translate from a noisy input source. If the input clock is known to be fairly clean or if some modulation on the input needs to be tracked. then the high-bandwidth frequency translation mode can be used, without the need for the external crystal.

The input clock references and crystal input are monitored continuously and appropriate alarms are raised both as register bits and hard-wired pins in the event of any out-of-specification conditions arising. Clock switching is supported in manual, revertive & non-revertive modes.

The IDT8T49N222I has one factory-programmed configuration that sets the default operating state after reset. These defaults may be over-written by I²C register access at any time, but those over-written settings will be lost on power-down. Please contact IDT if a specific set of power-up default settings is desired. Users that have a custom configuration programmed may not require I²C access.

Please make use of IDT-provided configuration tools to determine the best operating settings for the desired configurations of the device. Please refer to the Universal Frequency Translator Family Programming Guide if further details are required.

Operating Modes

The IDT8T49N222I has three operating modes which are set by the MODE_SEL[1:0] bits. There are two frequency translator modes - low bandwidth and high bandwidth and a frequency synthesizer mode.

Please make use of IDT-provided configuration applications to determine the best operating settings for the desired configurations of the device.

Output Dividers & Supported Output Frequencies

The internal VCO is capable of operating in a range from 1.850GHz up to 2.5GHz. The output divider stages N0[7:0] and N1[7:0] are limited to selection of integers from 2 to 254. Please refer to Table 3A for the recommended values of N applicable to the desired output frequency.

Table 3A. Output Divider Settings & Frequency Ranges*

Register Setting	Frequency Divider	Minimum f _{OUT}	Maximum f _{OUT}
Nn[7:0]	Nn	(MHz)	(MHz)
000000x		Not Supported	d
0000010	2	925.00	1200.00
00000011	3	616.67	833.33
00000100	4	462.50	625.00
00000101	5	370.00	500.00
00000110	6	308.33	416.67
00000111	7	264.29	357.14
00001000	8	231.25	312.50
00001001	9	205.56	277.78
00001010	10	185.00	250.00
		••	
11111110	254	7.29	9.84

*NOTE: Frequency ranges for other N output dividers are possible. Contact IDT Factory for special cases.

In addition to the above output divider settings, it is possible for either or both of the outputs to present a copy of the currently active input reference frequency by asserting the appropriate BYPn register bit.

Below are some example configurations for some common frequency combinations. Please use the IDT Configuration SW or consult with IDT to select other options.

Table 3B. Common Frequency Combination Examples

Output Frequency (MHz)	Output Divider Ratio	VCO Operating Frequency (MHz)	
125	15	1875	
156.25	12	1075	
25	75	1875	
156.25	12	1075	
25	80	2000	
125	16	2000	
155.52	12	1866.24	
622.08	3	1000.24	
19.44	96	1866.24	
622.08	3	1000.24	
161.1328125	12	1933.59375	
644.53125	3	1933.39373	
156.25	12	1875	
625	3	1675	
122.88	20	2457.6	
614.4	4	2457.0	
245.76	10	2457.6	
614.4	4	2437.0	
30.72	80	2457.6	
614.4	4	2437.0	
153.6	16	2457.6	
614.4	4	2437.0	
15.36	144	2211.84	
737.28	3	2211.04	
125	16	2000	
133.3333	15	2000	
32.76	60	1965.6	
131.04	15	0.0061	
26.5625	80	2125	
212.5	10	2120	
106.25	18	1912.5	
318.75	6	1012.0	

Frequency Synthesizer Mode

This mode of operation allows an arbitrary output frequency to be generated from a fundamental mode crystal input. For improved phase noise performance, the crystal input frequency may be doubled. As can be seen from the block diagram in *Figure 1*, only the upper feedback loop is used in this mode of operation. It is recommended that CLK0 and CLK1 be left unused in this mode of operation.

The upper feedback loop supports a delta-sigma fractional feedback divider. This allows the VCO operating frequency to be a non-integer multiple of the crystal frequency. By using an integer multiple only, lower phase noise jitter on the output can be achieved, however the use of the delta-sigma divider logic will provide excellent performance on the output if a fractional divisor is used.

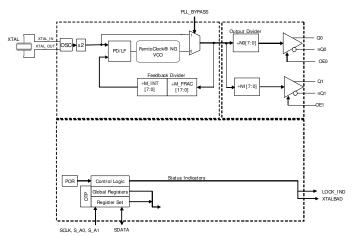


Figure 1. Frequency Synthesizer Mode Block Diagram

High-Bandwidth Frequency Translator Mode

This mode of operation is used to translate one of two input clocks of the same nominal frequency into an output frequency with little jitter attenuation. As can be seen from the block diagram in Figure 2, similarly to the Frequency Synthesizer mode, only the upper feedback loop is used.

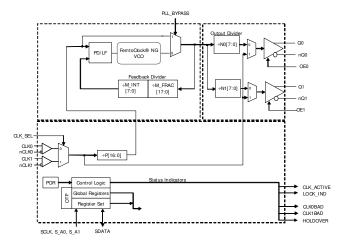


Figure 2. High Bandwidth Frequency Translator Mode Block Diagram

The input reference frequency range is now extended up to 710MHz. A pre-divider stage P is needed to keep the operating frequencies at the phase detector below 100MHz.

Low-Bandwidth Frequency Translator Mode

As can be seen from the block diagram in Figure 3, this mode involves two PLL loops. The lower loop with the large integer dividers is the low bandwidth loop and it sets the output-to-input frequency translation ratio. This loop drives the upper DCXO loop (digitally controlled crystal oscillator) via an analog-digital converter.

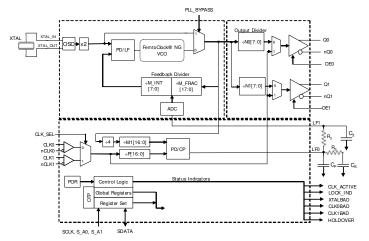


Figure 3. Low Bandwidth Frequency Translator Mode Block Diagram

The pre-divider stage is used to scale down the input frequency by an integer value to achieve a frequency in this range. By dividing down the fed-back VCO operating frequency by the integer divider M1[16:0] to as close as possible to the same frequency, exact output frequency translations can be achieved. The phase detector of the lower loop is designed to work with frequencies in the 8kHz - 16kHz range. For improved phase noise performance, the crystal input frequency may be doubled.

Alarm Conditions & Status Bits

The IDT8T49N222I monitors a number of conditions and reports their status via both output pins and register bits.

 $\ensuremath{\mathsf{CLK_ACTIVE}}$ - indicates which input clock reference is being used to derive the output frequency.

LOCK_IND - This status is asserted on the pin & register bit when the PLL is locked to the appropriate input reference for the chosen mode of operation. The status bit will not assert until a stable lock has been achieved, but will de-assert once lock is lost.

XTALBAD - indicates if valid edges are being received on the crystal input. Detection is performed by comparing the input to the feedback signal at the upper loop's Phase / Frequency Detector (PFD). If three edges are received on the feedback without an edge on the crystal input, the XTALBAD alarm is asserted on the pin & register bit. Once an edge is detected on the crystal input, the alarm is immediately deasserted.

CLK0BAD - indicates if valid edges are being received on the CLK0 reference input. Detection is performed by comparing the input to the feedback signal at the appropriate Phase / Frequency Detector (PFD). When operating in high-bandwidth mode, the feedback at the upper PFD is used. In low-bandwidth mode, the feedback at the lower PFD is used. If three edges are received on the feedback without an edge on the CLK0 reference input, the CLK0BAD alarm is asserted on the pin & register bit. Once an edge is detected on the CLK0 reference input, the alarm is deasserted.

CLK1BAD - indicates if valid edges are being received on the CLK1 reference input. Behavior is as indicated for the CLK0BAD alarm, but with the CLK1 input being monitored and the CLK1BAD output pin & register bits being affected.

HOLDOVER - indicates that the device is not locked to a valid input reference clock. This can occur in Manual switchover mode if the selected reference input has gone bad, even if the other reference input is still good. In automatic mode, this will only assert if both input references are bad.

Input Reference Selection and Switching

Both input references CLK0 and CLK1 must be the same nominal frequency. These may be driven by any type of clock source, including crystal oscillator modules. A difference in frequency may cause the PLL to lose lock when switching between input references. Please contact IDT for the exact limits for your situation.

The global control bits AUTO_MAN[1:0] dictate the order of priority and switching mode to be used between the CLK0 and CLK1 inputs.

Manual Switching Mode

When the AUTO_MAN[1:0] field is set to Manual via Pin, then the IDT8T49N222I will use the CLK_SEL input pin to determine which input to use as a reference. Similarly, if set to Manual via Register, then the device will use the CLK_SEL register bit to determine the input reference. In either case, the PLL will lock to the selected reference if there is a valid clock present on that input.

If there is not a valid clock present on the selected input, the IDT8T49N222I will go into holdover state and the HOLDOVER alarm will be raised. This will occur even if there is a valid clock on the non-selected reference input. The device will recover from holdover state once a valid clock is re-established on the selected reference input.

The IDT8T49N222I will only switch input references on command from the user. The user must either change the CLK_SEL register bit (if in Manual via Register) or CLK_SEL input pin (if in Manual via Pin).

Automatic Switching Mode

When the AUTO_MAN[1:0] field is set to either of the automatic selection modes (Revertive or Non-Revertive), the IDT8T49N222I determines which input reference it prefers / starts from by the state of the CLK_SEL register bit only. The CLK_SEL input pin is not used in either Automatic switching mode.

When starting from an unlocked condition, the device will lock to the input reference indicated by the CLK_SEL register bit. It will not pay

attention to the non-selected input reference until a locked state has been achieved. This is necessary to prevent 'hunting' behavior during the locking phase.

Once the IDT8T49N222I has achieved a stable lock, it will remain locked to the preferred input reference as long as there is a valid clock on it. If at some point, that clock fails, then the device will automatically switch to the other input reference as long as there is a valid clock there. If there is not a valid clock on either input reference, the IDT8T49N222I will go into holdover state and the HOLDOVER alarm will be raised.

The device will recover from holdover state once a valid clock is re-established on either reference input. If clocks are valid on both input references, the device will choose the reference indicated by the CLK_SEL register bit.

If running from the non-preferred input reference and a valid clock returns, there is a difference in behavior between Revertive and Non-revertive modes. In Revertive mode, the device will switch back to the reference indicated by the CLK_SEL register bit even if there is still a valid clock on the non-preferred reference input. In Non-revertive mode, the IDT8T49N222I will not switch back as long as the non-preferred input reference still has a valid clock on it.

Switchover Behavior of the PLL

Even though the two input references have the same nominal frequency, there may be minor differences in frequency and potentially large differences in phase between them. The IDT8T49N222I will adjust its output to the new input reference. It will use Phase Slope Limiting to adjust the output phase at a fixed maximum rate until the output phase and frequency are now aligned to the new input reference. Phase will always be adjusted by extending the clock period of the output so that no unacceptably short clock periods are generated on the output IDT8T49N222I.

Holdover / Free-run Behavior

When both input references have failed (Automatic mode) or the selected input has failed (Manual mode), the IDT8T49N222I will enter holdover (Low Bandwidth Frequency Translator mode) or free-run (High Bandwidth Frequency Translator mode) state if. In both cases, once the input reference is lost, the PLL will stop making adjustments to the output phase.

If operating in Low Bandwidth Frequency Translation mode, the PLL will continue to reference itself to the local oscillator and will hold its output phase and frequency in relation to that source. Output stability is determined by the stability of the local oscillator in this case.

However, if operating in High Bandwidth Frequency Translation mode, the PLL no longer has any frequency reference to use and output stability is now determined by the stability of the internal VCO.

If the device is programmed to perform Manual switching, once the selected input reference recovers, the IDT8T49N222I will switch back to that input reference. If programmed for either Automatic mode, the device will switch back to whichever input reference has a valid clock first.

The switchover that results from returning from holdover or free-run is handled in the same way as a switch between two valid input references as described in the previous section.

Output Configuration

The two outputs of the IDT8T49N222I provide separate output frequencies. Each output may have a different output voltage level of 3.3V or 2.5V, although this output voltage must be less than or equal to the core voltage (3.3V or 2.5V) the rest of the device is operating from. The output voltage level used on each output is supplied on their respective $V_{\rm CCO}$ pin.

The two outputs are individually selectable as LVDS or LVPECL output types via the Qn_TYPE register bits (where n=0 for Q0 / nQ0 and n=1 for the Q1 / nQ1 output pair).

The two outputs can be enabled individually also via both register control bits and input pins. When both the OEn register bit and OEn pin are enabled, then the appropriate output is enabled. The OEn register bits default to enabled so that by default the outputs can be directly controlled by the input pins. Similarly, the input pins are provisioned with weak pull-ups so that if they are left unconnected, the output state can be directly controlled by the register bits. When the differential output is in the disabled state, it will show a high impedance condition.

Serial Interface Configuration Description

The IDT8T49N222I has an I²C-compatible configuration interface to access any of the internal registers (Table 4D) for frequency and PLL parameter programming. The IDT8T49N222I acts as a slave device on the I²C bus and has the address 0b11011xx, where xx is set by the values on the S_A0 & S_A1 pins (see Table 4A for details). The interface accepts byte-oriented block write and block read operations. An address byte (P) specifies the register address (Table 4D) as the byte position of the first register to write or read. Data bytes (registers) are accessed in sequential order from the lowest to the highest byte (most significant bit first, see table 4B, 4C). Read and write block transfers can be stopped after any complete byte transfer. It is recommended to terminate I²C the read or write transfer after accessing byte #23.

For full electrical ${}^{12}\text{C}$ compliance, it is recommended to use external pull-up resistors for SDATA and SCLK. The internal pull-up resistors have a size of $50\text{k}\Omega$ typical.

Note: if a different device slave address is desired, please contact IDT.

Table 4A. I²C Device Slave Address

1 1 0	1 1	S_A1	S_A0	R/W
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Table 4B. Block Write Operation

Bit	1	2:8	9	10	11:18	19	20:27	28	29-36	37	•••		
Description	START	Slave Address	W (0)	ACK	Address Byte (P)	ACK	Data Byte (P)	ACK	Data Byte (P+1)	ACK	Data Byte	ACK	STOP
Length (bits)	1	7	1	1	8	1	8	1	8	1	8	1	1

Table 4C. Block Read Operation

Bit	1	2:8	9	10	11:18	19	20	21:27	28	29	30:37	38	39-46	47			
Description	START	Slave Address	W (0)	A C K	Address Byte (P)	A C K	Repeated START	Slave Address	R (1)	A C K	Data Byte (P)	A C K	Data Byte (P+1)	A C K	Data Byte	A C K	STOP
Length (bits)	1	7	1	1	8	1	1	7	1	1	8	1	8	1	8	1	1

Register Descriptions

Please consult IDT for configuration software and/or programming guides to assist in selection of optimal register settings for the desired configurations.

Table 4D. I²C Register Map

	Binary				Register Bi	t			
Reg	Regist er Addre ss	D 7	D6	D5	D4	D3	D2	D1	D0
0	00000	MFRAC[17]	MFRAC0[16]	MFRAC0[15]	MFRAC0[14]	MFRAC0[13]	MFRAC0[12]	MFRAC0[11]	MFRAC0[10]
1	00001	Rsvd	Rsvd	Rsvd	Rsvd	Rsvd	Rsvd	Rsvd	Rsvd
2	00010	MFRAC0[9]	MFRAC0[8]	MFRAC0[7]	MFRAC0[6]	MFRAC0[5]	MFRAC0[4]	MFRAC0[3]	MFRAC0[2]
3	00011	Rsvd	Rsvd	Rsvd	Rsvd	Rsvd	Rsvd	Rsvd	Rsvd
4	00100	MFRAC0[1]	MFRAC0[0]	MINT[7]	MINT[6]	MINT[5]	MINT[4]	MINT[3]	MINT[2]
5	00101	Rsvd	Rsvd	Rsvd	Rsvd	Rsvd	Rsvd	Rsvd	Rsvd
6	00110	MINT[1]	MINT[0]	P[16]	P[15]	P[14]	P[13]	P[12]	P[11]
7	00111	Rsvd	Rsvd	Rsvd	Rsvd	Rsvd	Rsvd	Rsvd	Rsvd
8	01000	P[10]	P[9]	P[8]	P[7]	P[6]	P[5]	P[4]	P[3]
9	01001	Rsvd	Rsvd	Rsvd	Rsvd	Rsvd	Rsvd	Rsvd	Rsvd
10	01010	P[2]	P[1]	P[0]	M1[16]	M1[15]	M1[14]	M1[13]	M1[12]
11	01011	Rsvd	Rsvd	Rsvd	Rsvd	Rsvd	Rsvd	Rsvd	Rsvd
12	01100	M1[11]	M1[10]	M1[9]	M1[8]	M1[7]	M1[6]	M1[5]	M1[4]
13	01101	Rsvd	Rsvd	Rsvd	Rsvd	Rsvd	Rsvd	Rsvd	Rsvd
14	01110	M1[3]	M1[2]	M1[1]	M1[0]	Rsvd	Rsvd	Rsvd	Rsvd
15	01111	Rsvd	Rsvd	Rsvd	Rsvd	Rsvd	Rsvd	Rsvd	Rsvd
16	10000	N0[7]	N0[6]	N0[5]	N0[4]	N0[3]	N0[2]	N0[1]	N0[0]
17	10001	N1[7]	N1[6]	N1[5]	N1[4]	N1[3]	N1[2]	N1[1]	N1[0]
18	10010	Rsvd	BW[6]	BW[5]	BW[4]	BW[3]	BW[2]	BW[1]	BW[0]
19	10011	DBL_XTAL	Re-Calibrate	OE1	OE0	Q1_TYPE	Q0_TYPE	BYP1	BYP0
20	10100	MODE_SEL1	MODE_SEL0	0	0	Rsvd	Rsvd	Rsvd	Rsvd
21	10101	CLK_SEL	AUTO_MAN[1]	AUTO_MAN[0]	0	ADC_RATE[1]	ADC_RATE[0]	LCK_WIN[1]	LCK_WIN[0]
22	10110	1	0	1	0	0	0	0	0
23	10111	CLK_ACTIVE	HOLDOVER	CLK1BAD	CLK0BAD	XTAL_BAD	LOCK_IND	Rsvd	Rsvd

Table 4E. Control Bits

Register Bits	Function
Q0_TYPE	Determines the output type for output pair Q0, nQ0. 0 = LVPECL (Default) 1 = LVDS
Q1_TYPE	Determines the output type for output pair Q1, nQ1. 0 = LVPECL (Default) 1 = LVDS
BYP0	Bypass Input to output Q0. 0 = Use result of output divider N0 (Default) 1 = Drive currently active input reference frequency on output
BYP1	Bypass Input to output Q1. 0 = Use result of output divider N1 (Default) 1 = Drive currently active input reference frequency on output
P[16:0]	Reference Pre-Divider.
M1[16:0]	Integer Feedback Divider in Lower Feedback Loop.
M_INT[7:0]	Feedback Divider, Integer Value in Upper Feedback Loop.
M_FRAC[17:0]	Feedback Divider, Fractional Value in Upper Feedback Loop.
N0[7:0]	Output Divider for Q0, nQ0.
N1[7:0]	Output Divider for Q1, nQ1.
BW[6:0]	Internal Operation Settings. Please use IDT IDT8T49N222I Configuration Software to determine the correct settings for these bits for the specific configuration. Alternatively, please consult with IDT directly for further information on the functions of these bits. The function of these bits is explained in Tables 4H and 4I.
Re-calibrate	This bit is asserted to force a VCO calibration cycle. The bit needs to be returned to '0' to resume normal operation. This is only needed if the P[16:0], M_INT[7:0] or M_FRAC[17:0] registers are changed after power-up. The device automatically calibrate the VCO on power-up.
Rsvd	Reserved bits - user should write a '0' to these bit positions if a write to these registers is needed.

Table 4F. Global Control Bits

Register Bits	Function
OE0	Output Enable Control for Output 0. Both this register bit and the corresponding Output Enable pin OE0 must be asserted to enable the Q0, nQ0 output. 0 = Output Q0, nQ0 disabled 1 = Output Q0, nQ0 under control of the OE0 pin (Default)
OE1	Output Enable Control for Output 1. Both this register bit and the corresponding Output Enable pin OE1 must be asserted to enable the Q1, nQ1 output. 0 = Output Q1, nQ1 disabled 1 = Output Q1, nQ1 under control of the OE1 pin (Default)
AUTO_MAN[1:0]	Selects how input clock selection is performed. 00 = Manual Selection via pin only (Default) 01 = Automatic, non-revertive 10 = Automatic, revertive 11 = Manual Selection via register only
CLK_SEL	In manual clock selection via register mode, this bit will command which input clock is selected. In the automatic modes, this indicates the primary clock input. In manual selection via pin mode, this bit has no effect. 0 = CLK0 (Default) 1 = CLK1
DBL_XTAL	When set, enables the crystal frequency doubler circuit.
ADC_RATE[1:0]	Sets the ADC sampling as a fraction of the crystal input frequency. 00 = Crystal Frequency ÷16 01 = Crystal Frequency ÷8 10 = Crystal Frequency ÷4 (recommended) 11 = Crystal Frequency ÷2
LCK_WIN[1:0]	Sets the width of the window in which a new reference edge must fall relative to the feedback edge: $00 = 2\mu S$ (default), $01 = 4\mu S$, $10 = 8\mu S$, $11 = 16\mu S$
MODE_SEL[1:0]	PLL mode select. 00 = Low Bandwidth Mode (default) 01 = Frequency Synthesizer Mode 10 = High Bandwidth Mode 11 = High Bandwidth Mode

Table 4G. Global Status Bits

Register Bits	Function
CLK0BAD	Status Bit for input CLK0. This function is mirrored in the CLK0BAD pin. 0 = input CLK0 is good 1 = input CLK0 is bad. Self clears when input clock returns to good status
CLK1BAD	Status Bit for input CLK1. This function is mirrored in the CLK1BAD pin. 0 = input CLK1 is good 1 = input CLK1 is bad. Self clears when input clock returns to good status
XTALBAD	Status Bit. This function is mirrored on the XTALBAD pin. 0 = crystal input is good 1 = crystal input is bad. Self-clears when the XTAL clock returns to good status
LOCK_IND	Status bit. This function is mirrored on the LOCK_IND pin. 0 = PLL is unlocked 1 = PLL is locked
HOLDOVER	Status Bit. This function is mirrored on the HOLDOVER pin. 0 = Input to phase detector is within specifications and device is tracking to it 1 = Phase detector input is not within specifications and DCXO is frozen at last value
CLK_ACTIVE	Status Bit. Indicates which input clock is active. Automatically updates during fail-over switching. Status also indicated on CLK_ACTIVE pin.

Table 4H. BW[6:0] Bits

Mode	BW[6]	BW[5]	BW[4]	BW[3]	BW[2]	BW[1]	BW[0]
Synthesizer Mode	PLL2_LF[1]	PLL2_LF[0]	DSM_ORD	DSM_EN	PLL2_CP[1]	PLL2_CP[0]	PLL2_LOW_ICP
High-Bandwidth Mode	PLL2_LF[1]	PLL2_LF[0]	DSM_ORD	DSM_EN	PLL2_CP[1]	PLL2_CP[0]	PLL2_LOW_ICP
Low-Bandwidth Mode	ADC_GAIN[3]	ADC_GAIN[2]	ADC_GAIN[1]	ADC_GAIN[0]	PLL1_CP[1]	PLL1_CP[0]	PLL2_LOW_ICP

Table 4I. Functions of Fields in BW[6:0]

Register Bits	Function
PLL2_LF[1:0]	Sets loop filter values for upper loop PLL in Frequency Synthesizer & High-Bandwidth modes. Defaults to setting of 00 when in Low Bandwidth Mode. See Table 4L for settings.
DSM_ORD	Sets Delta-Sigma Modulation to 2nd (0) or 3rd order (1) operation.
DSM_EN	Enables Delta-Sigma Modulator. 0 = Disabled - feedback in integer mode only 1 = Enabled - feedback in fractional mode
PLL2_CP[1:0]	Upper loop PLL charge pump current settings. $00 = 173 \mu A$ (defaults to this setting in Low Bandwidth Mode) $01 = 346 \mu A$ $10 = 692 \mu A$ 11 = reserved
PLL2_LOW_ICP	Reduces Charge Pump current by 1/3 to reduce bandwidth variations resulting from higher feedback register settings or high VCO operating frequency (>2.4GHz).
ADC_GAIN[3:0]	Gain setting for ADC in Low Bandwidth Mode.
PLL1_CP[1:0]	Lower loop PLL charge pump current settings (lower loop is only used in Low Bandwidth Mode). $00=800\mu A$ $01=400\mu A$ $10=200\mu A$ $11=100\mu A$

Table 4J. High Bandwidth Frequency and Frequency Synthesizer Bandwidth Settings

Desired Bandwidth	PLL2_CP	PLL2_LOW_ICP	PLL2_LF						
	Frequency Synthesizer Mode								
200kHz	00	1	00						
400kHz	01	1	01						
800kHz	10	1	10						
2MHz	10	1	11						
High I	Bandwidth Frequ	ency Translator Mode							
200kHz	00	1	00						
400kHz	01	1	01						
800kHz	10	1	10						
4MHz	10	0	11						

NOTE: To achieve 4MHz bandwidth, reference to the phase detector should be 80MHz.

Absolute Maximum Ratings

NOTE: Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These ratings are stress specifications only. Functional operation of product at these conditions or any conditions beyond those listed in the *DC Characteristics* or *AC Characteristics* is not implied. Exposure to absolute maximum rating conditions for extended periods may affect product reliability.

Item	Rating
Supply Voltage, V _{CC}	3.6V
Inputs, V _I XTAL_IN OEx Other Inputs	0V to 2V -0.5V to V _{CCOx} + 0.5V -0.5V to V _{CC} + 0.5V
Outputs, V _O (LVCMOS)	-0.5V to V _{CC} + 0.5V
Outputs, I _O (LVPECL) Continuous Current Surge Current	50mA 100mA
Outputs, I _O (LVDS) Continuous Current Surge Current	10mA 15mA
Outputs, I _O (SDATA)	10mA
Package Thermal Impedance, θ_{JA}	29°C/W (0 mps)
Storage Temperature, T _{STG}	-65°C to 150°C

DC Electrical Characteristics

Table 5A. Power Supply DC Characteristics, $V_{CC} = V_{CCO0} = V_{CCO1} = 3.3V \pm 5\%$, $V_{EE} = 0V$, $T_A = -40^{\circ}C$ to $85^{\circ}C$

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
V _{CC}	Core Supply Voltage		3.135	3.3	3.465	V
V_{CCA}	Analog Supply Voltage		V _{CC} - 0.30	3.3	V _{CC}	V
V _{CCOo,} V _{CCO1}	Output Supply Voltage		3.135	3.3	3.465	V
I _{EE}	Power Supply Current				358	mA
I _{CCA}	Analog Supply Current	With V_{CCA} pin connected to power supply via 10Ω resistor			30	mA

Table 5B. LVPECL Power Supply DC Characteristics, $V_{CC} = 3.3V \pm 5\%$, $V_{CCO0} = V_{CCO1} = 2.5V \pm 5\%$, $V_{EE} = 0V$, $T_A = -40^{\circ}C$ to $85^{\circ}C$

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
V _{CC}	Core Supply Voltage		3.135	3.3	3.465	V
V _{CCA}	Analog Supply Voltage		V _{CC} - 0.30	3.3	V _{CC}	V
V _{CCOo,} V _{CCO1}	Output Supply Voltage		2.375	2.5	2.625	V
I _{EE}	Power Supply Current				357	mA
I _{CCA}	Analog Supply Current	With V_{CCA} pin connected to power supply via 10Ω resistor			30	mA

Table 5C. Power Supply DC Characteristics, $V_{CC} = V_{CCO0} = V_{CCO1} = 2.5 V \pm 5\%$, $V_{EE} = 0 V$, $T_A = -40 ^{\circ} C$ to $85 ^{\circ} C$

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
V _{CC}	Core Supply Voltage		2.375	2.5	2.625	V
V _{CCA}	Analog Supply Voltage		V _{CC} - 0.26	2.5	V _{CC}	٧
V _{CCO0} , V _{CCO1}	Output Supply Voltage		2.375	2.5	2.625	V
I _{EE}	Power Supply Current				328	mA
I _{CCA}	Analog Supply Current	With V_{CCA} pin connected to power supply via 10Ω resistor			26	mA

Symbol	Parameter		Test Conditions	Minimum	Typical	Maximum	Units
V	Input High Vol	togo	V _{CC} = 3.3V	2		V _{CC} + 0.3	V
V _{IH}	Input High Vol	lage	V _{CC} = 2.5V	1.7		V _{CC} + 0.3	V
V	Input Low Volt	200	V _{CC} = 3.3V	-0.3		0.8	V
V _{IL}	input Low voit	aye	V _{CC} = 2.5V	-0.3		0.7	V
		CLK_SEL, PLL_BYPASS, S_A[0:1]	V _{CC} = V _{IN} = 3.465V or 2.625V			150	μΑ
I _{IH}	Input	SCLK, SDATA	V _{CC} = V _{IN} = 3.465V or 2.625V			10	μΑ
	High Current	OE0	$V_{CCO0} = V_{IN} = 3.465V \text{ or } 2.625V$			5	μΑ
		OE1	$V_{CCO1} = V_{IN} = 3.465V \text{ or } 2.625V$			5	μΑ
	Input	CLK_SEL, PLL_BYPASS, S_A[0:1]	V _{CC} = 3.465V or 2.625V, V _{IN} = 0V	-5			μΑ
I _{IL}	Low Current	OE0, OE1, SCLK, SDATA	V _{CC} = 3.465V or 2.625V, V _{IN} = 0V	-150			μΑ
		HOLDOVER, SDATA	V _{CC} = 3.465V, I _{OH} = -8mA	2.6			V
V _{OH}	Output High Voltage	CLK_ACTIVE, LOCK_IND, XTALBAD, CLK0BAD, CLK1BAD	V _{CC} = 2.625V, I _{OH} = -8mA	1.8			V
V _{OL}	Output Low Voltage	HOLDOVER, SDATA CLK_ACTIVE, LOCK_IND, XTALBAD, CLK0BAD, CLK1BAD	V _{CC} = 3.465V or 2.625V, I _{OH} = 8mA			0.5	V

Symbol	Parameter		Test Conditions	Minimum	Typical	Maximum	Units
I _{IH}	Input High Current	CLK0, nCLK0, CLK1, nCLK1	V _{CC} = V _{IN} = 3.465V or 2.625V			150	μΑ
I _{IL}	Input Low Current	CLK0, CLK1 nCLK0, nCLK1	$V_{CC} = 3.465V \text{ or } 2.625V, V_{IN} = 0V$ $V_{CC} = 3.465V \text{ or } 2.625V, V_{IN} = 0V$	-5 -150			μA μA
V _{PP}	Peak-to-Peak	Voltage	7 114	0.15		1.3	V
V _{CMR}	Common Mod NOTE 1	e Input Voltage;		V _{EE} + 0.5		V _{CC} - 1.0	V

NOTE 1: Common mode input voltage is defined at the crosspoint.

Table 5F. LVPECL DC Characteristics, $V_{CC} = V_{CCO0} = V_{CCO1} = 3.3V \pm 5\%$ or $2.5V \pm 5\%$; or $V_{CC} = 3.3V \pm 5\%$, $V_{CCO0} = V_{CCO1} = 2.5V \pm 5\%$, $V_{EE} = 0V$, $T_A = -40^{\circ}C$ to $85^{\circ}C$

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
V _{OH}	Output High Voltage; NOTE 1		V _{CCOx} – 1.1		V _{CCOx} - 0.7	V
V _{OL}	Output Low Voltage NOTE 1		V _{CCOx} - 2.0		V _{CCOx} - 1.5	٧
V _{SWING}	Peak-to-Peak Output Voltage Swing		0.6		1.0	V

NOTE: V_{CCO_X} denotes V_{CCO_0} (Q0, nQ0) and V_{CCO_1} (Q1, nQ1). NOTE 1: Outputs terminated with 50Ω to V_{CCO_X} – 2V.

Table 5G. LVDS DC Characteristics, $V_{CC} = V_{CCO0} = V_{CCO1} = 3.3V \pm 5\%$ or $2.5V \pm 5\%$, $V_{EE} = 0V$, $T_A = -40^{\circ}C$ to $85^{\circ}C$

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
V _{OD}	Differential Output Voltage		247		454	mV
ΔV_{OD}	V _{OD} Magnitude Change				50	mV
V _{OS}	Offset Voltage		1.125		1.375	V
ΔV_{OS}	V _{OS} Magnitude Change				50	mV

Table 6. Input Frequency Characteristics, V_{CC} = 3.3V ±5% or 2.5V ±5%, V_{EE} = 0V, T_A = -40°C to 85°C

Symbol	Parameter		Test Conditions	Minimum	Typical	Maximum	Units
		XTAL_IN, XTAL_OUT; NOTE 1		16		40	MHz
f _{IN}	Input	Input Frequency CLK0, nCLK0, CLK1, nCLK1	High Bandwidth Mode	16		710	MHz
"	riequency		Low Bandwidth Mode	0.008		710	MHz
		SCLK				50	MHz

NOTE 1: For the input crystal and CLKx, nCLKx frequency range, the M value must be set for the VCO to operate within the 1.850GHz to 2.500GHz range.

Table 7. Crystal Characteristics

Parameter	Test Conditions	Minimum	Typical	Maximum	Units
Mode of Oscillation					
Frequency		16		40	MHz
Load Capacitance (C _L)			12		pF
Shunt Capacitance				7	pF

AC Electrical Characteristics

Table 8. AC Characteristics, $V_{CC} = V_{CCO0} = V_{CCO1} = 3.3V \pm 5\%$ or $2.5V \pm 5\%$; or $V_{CC} = 3.3V \pm 5\%$, $V_{CCO0} = V_{CCO1} = 2.5V \pm 5\%$ (LVPECL Only), $V_{EE} = 0V$, $T_{A} = -40^{\circ}C$ to $85^{\circ}C$

Symbol	Parameter		Test Conditions	Minimum	Typical	Maximum	Units
f _{OUT}	Output Frequency			7.29		1200	MHz
f _{VCO}	VCO Frequency			1850		2500	MHz
tjit(∅)	RMS Phase Jitter (Random), Integer Divide Ratio		Synth Mode (Integer FB), f _{OUT} = 125MHz, 25MHz XTAL, Integration Range: 12kHz – 20MHz		278	350	fs
			Synth Mode (FracN FB), f _{OUT} = 698.81MHz, 40MHz XTAL, Integration Range: 12kHz – 20MHz		481	590	fs
			HBW Mode, (NOTE 3) f _{IN} = 133.33MHz, f _{OUT} = 400MHz, Integration Range: 12kHz – 20MHz		306	570	fs
			LBW Mode (FracN), 40MHz XTAL, f _{IN} = 19.44MHz, f _{OUT} = 622.08MHz, Integration Range: 12kHz – 20MHz		425	540	fs
			LBW Mode (FracN), 40MHz XTAL, f _{IN} = 25MHz, f _{OUT} = 156.25MHz, Integration Range: 12kHz – 20MHz		508	680	fs
tjit(cc)	Cycle-to-Cycle Jitter; NOTE 1, 2		LBW Mode, 40MHz XTAL, f _{IN} = 25MHz, f _{OUT} = 156.25MHz			40	ps
tjit(per)	RMS Period Jitter; NOTE 2	LVPECL Outputs	LBW Mode, 40MHz XTAL, f _{IN} = 25MHz, f _{OUT} = 156.25MHz			3.5	ps
		LVDS Outputs				4	ps
t _R / t _F	Output Rise/Fall Time	LVPECL Outputs	20% to 80%	80		350	ps
		LVDS Outputs	20% to 80%	90		400	ps
odc	Output Duty Cycle; NOTE 5			45		55	%
t _{SET}	Output Re-configuration Settling Time		from falling edge of the 8th SCLK for a register change (NOTE 4)		200		ns

NOTE: Electrical parameters are guaranteed over the specified ambient operating temperature range, which is established when the device is mounted in a test socket with maintained transverse airflow greater than 500 lfpm. The device will meet specifications after thermal equilibrium has been reached under these conditions.

NOTE: Using 40MHz, fundamental mode crystal with 12pF (C₁) and the doubler circuit enabled.

NOTE 1: This parameter is defined in accordance with JEDEC Standard 65.

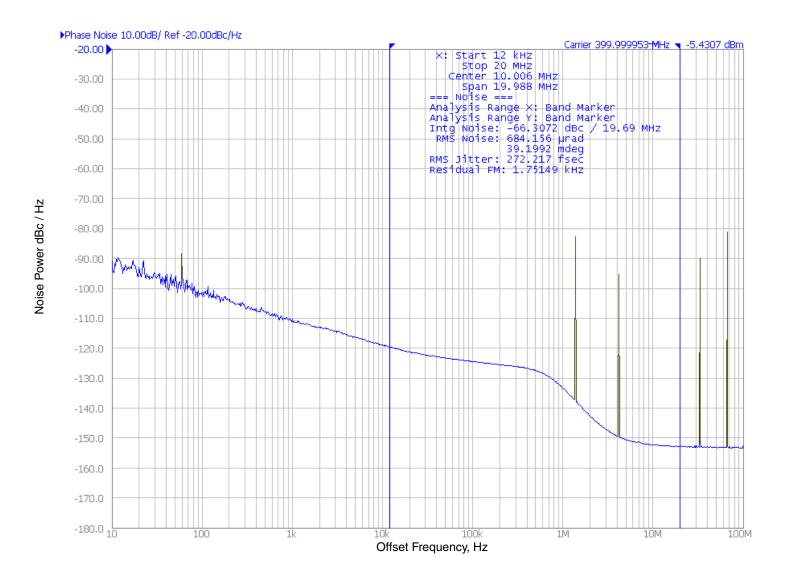
NOTE 2: This configuration corresponds to dash code -000.

NOTE 3: Measured using a Rohde & Schwarz SMA100 Signal Generator, 9kHz to 6GHz as the input source.

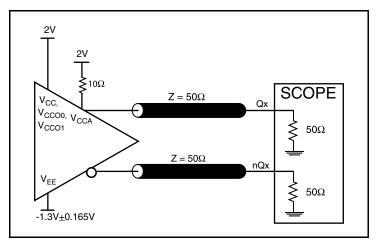
NOTE 4: This settling time does not include PLL re-calibration and locking if required. Since those times are highly dependent on the specific configuration, please contact IDT for times if PLL re-configuration is performed as part of the configuration change.

NOTE 5: Measurements are collected with the following output frequencies: 19.44MHz, 25MHz, 100MHz, 125MHz, 156.25MHz, 311.04MHz, 480MHz, 531.25MHz 600MHz, 622.08MHz, 1062.5MHz, 1200MHz.

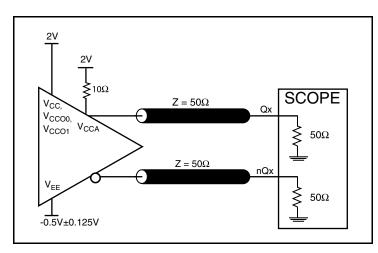
Typical Phase Noise at 400MHz (HBW Mode)



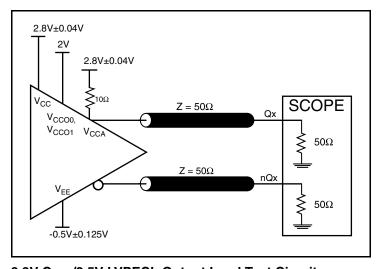
Parameter Measurement Information



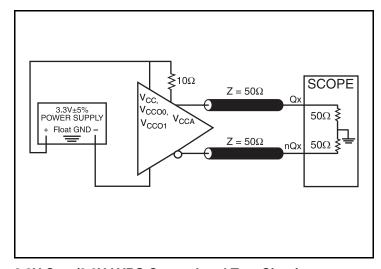
3.3V Core/3.3V LVPECL Output Load Test Circuit



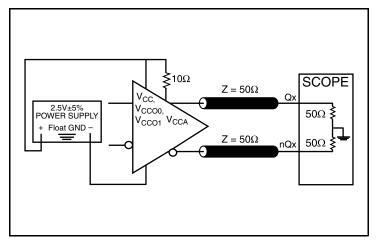
2.5V Core/2.5V LVPECL Output Load Test Circuit



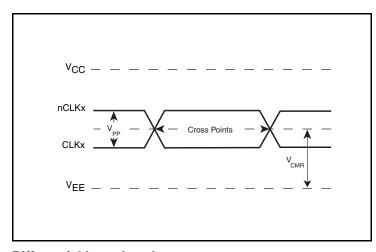
3.3V Core/2.5V LVPECL Output Load Test Circuit



3.3V Core/3.3V LVDS Output Load Test Circuit

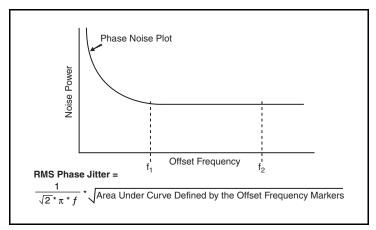


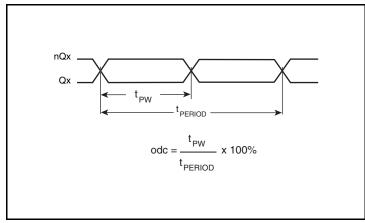
2.5V Core/2.5V LVDS Output Load Test Circuit



Differential Input Levels

Parameter Measurement Information, continued

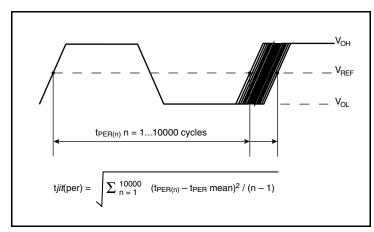




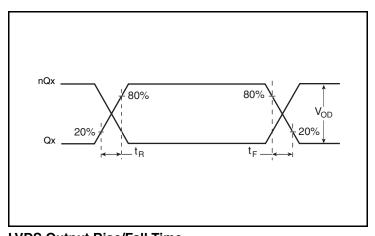
RMS Phase Jitter

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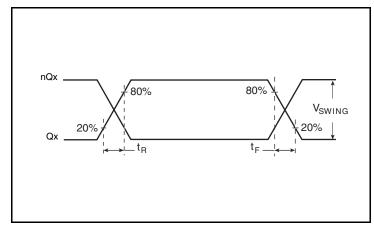
Differential Output Duty Cycle/Output Pulse Width/Period



Cycle-to-Cycle Jitter



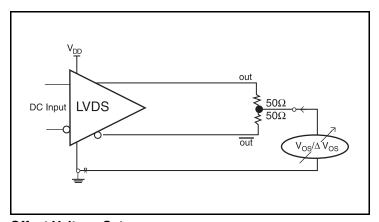
RMS Period Jitter

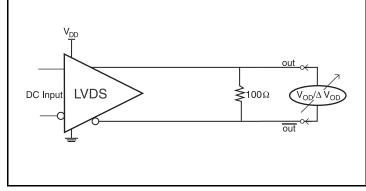


LVDS Output Rise/Fall Time

LVPECL Output Rise/Fall Time

Parameter Measurement Information, continued





Offset Voltage Setup

Differential Output Voltage Setup

Applications Information

Overdriving the XTAL Interface

The XTAL_IN input can be overdriven by an LVCMOS driver or by one side of a differential driver through an AC coupling capacitor. The XTAL_OUT pin can be left floating. The amplitude of the input signal should be between 500mV and 1.8V and the slew rate should not be less than 0.2V/nS. For 3.3V LVCMOS inputs, the amplitude must be reduced from full swing to at least half the swing in order to prevent signal interference with the power rail and to reduce internal noise. Figure 1A shows an example of the interface diagram for a high speed 3.3V LVCMOS driver. This configuration requires that the sum of the output impedance of the driver (Ro) and the series resistance (Rs) equals the transmission line impedance. In addition, matched termination at the crystal input will attenuate the signal in half. This

can be done in one of two ways. First, R1 and R2 in parallel should equal the transmission line impedance. For most 50Ω applications, R1 and R2 can be 100Ω . This can also be accomplished by removing R1 and changing R2 to 50Ω . The values of the resistors can be increased to reduce the loading for a slower and weaker LVCMOS driver. Figure 1B shows an example of the interface diagram for an LVPECL driver. This is a standard LVPECL termination with one side of the driver feeding the XTAL_IN input. It is recommended that all components in the schematics be placed in the layout. Though some components might not be used, they can be utilized for debugging purposes. The datasheet specifications are characterized and guaranteed by using a quartz crystal as the input.

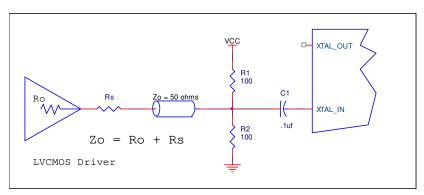


Figure 1A. General Diagram for LVCMOS Driver to XTAL Input Interface

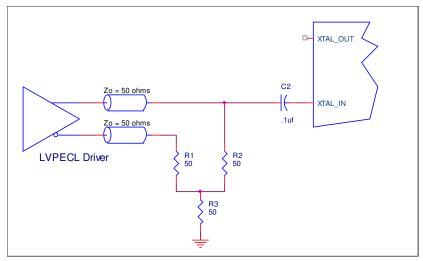


Figure 1B. General Diagram for LVPECL Driver to XTAL Input Interface

Wiring the Differential Input to Accept Single-Ended Levels

Figure 2 shows how a differential input can be wired to accept single ended levels. The reference voltage $V_1 = V_{CC}/2$ is generated by the bias resistors R1 and R2. The bypass capacitor (C1) is used to help filter noise on the DC bias. This bias circuit should be located as close to the input pin as possible. The ratio of R1 and R2 might need to be adjusted to position the V_1 in the center of the input voltage swing. For example, if the input clock swing is 2.5V and $V_{CC} = 3.3V$, R1 and R2 value should be adjusted to set V_1 at 1.25V. The values below are for when both the single ended swing and V_{CC} are at the same voltage. This configuration requires that the sum of the output impedance of the driver (Ro) and the series resistance (Rs) equals the transmission line impedance. In addition, matched termination at the input will attenuate the signal in half. This can be done in one of two ways. First, R3 and R4 in parallel should equal the transmission line

impedance. For most 50Ω applications, R3 and R4 can be 100Ω . The values of the resistors can be increased to reduce the loading for slower and weaker LVCMOS driver. When using single-ended signaling, the noise rejection benefits of differential signaling are reduced. Even though the differential input can handle full rail LVCMOS signaling, it is recommended that the amplitude be reduced. The datasheet specifies a lower differential amplitude, however this only applies to differential signals. For single-ended applications, the swing can be larger, however $V_{\rm IL}$ cannot be less than -0.3V and $V_{\rm IH}$ cannot be more than $V_{\rm CC}$ + 0.3V. Though some of the recommended components might not be used, the pads should be placed in the layout. They can be utilized for debugging purposes. The datasheet specifications are characterized and quaranteed by using a differential signal.

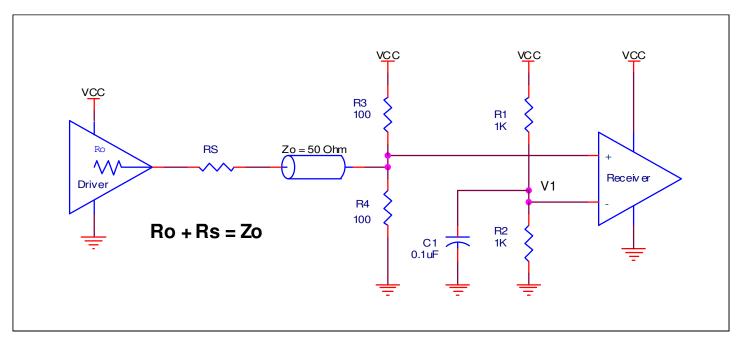


Figure 2. Recommended Schematic for Wiring a Differential Input to Accept Single-ended Levels

3.3V Differential Clock Input Interface

The CLK /nCLK accepts LVDS, LVPECL, LVHSTL, HCSL and other differential signals. Both differential signals must meet the V_{PP} and V_{CMR} input requirements. *Figures 3A to 3E* show interface examples for the CLK/nCLK input driven by the most common driver types. The input interfaces suggested here are examples only. Please consult

with the vendor of the driver component to confirm the driver termination requirements. For example, in Figure 3A, the input termination applies for IDT open emitter LVHSTL drivers. If you are using an LVHSTL driver from another vendor, use their termination recommendation.

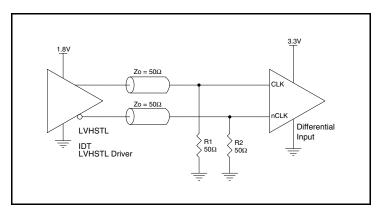


Figure 3A. CLK/nCLK Input Driven by an IDT Open Emitter LVHSTL Driver

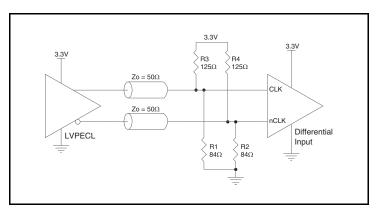


Figure 3C. CLK/nCLK Input Driven by a 3.3V LVPECL Driver

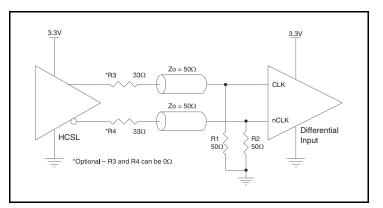


Figure 3E. CLK/nCLK Input Driven by a 3.3V HCSL Driver

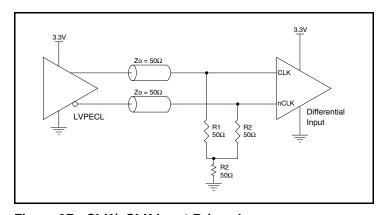


Figure 3B. CLK/nCLK Input Driven by a 3.3V LVPECL Driver

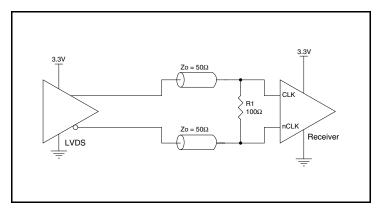


Figure 3D. CLK/nCLK Input Driven by a 3.3V LVDS Driver